AT25SF041



4-Mbit, 2.5V Minimum SPI Serial Flash Memory with Dual-I/O and Quad-I/O Support

DATASHEET (ADDENDUM)

High Temperature Operation (125°C)

This data sheet addendum is to be used in conjunction with the existing AT25SF041 datasheet specifications. The Adesto AT25SF041 4Mbit Serial Flash devices will operate @ 125°C with the following datasheet caveats. All other parameters will meet the existing datasheet specifications.

The ordering code suffix (CAN# Code) 'HR' or 'HT' must be used to ensure correct operation at this extended temperature range. Adesto will not modify and republish the current datasheet to reflect the CAN# 'HR' or 'HT' ordering code or the above caveats.The standard <u>AT25SF041 datasheet</u> is available at http://www.adestotech.com.

1. Electrical Specifications

1.1 DC and AC Operating Range

	AT25SF041-xxxHR
Operating Temperature	-40°C to +125°C
Endurance (Maximum)	10,000 Cycles

1.2 DC Characteristics

			2.5V to 3.6V			
Symbol	Parameter	Condition	Min	Тур	Max	Units
I _{DPD}	Deep Power-Down Current	$\overline{\text{CS}}, \overline{\text{HOLD}}, \overline{\text{WP}} = V_{\text{IH}}$			10 ⁽¹⁾	μA
I _{SB}	Standby Current	$\overline{\text{CS}}$, $\overline{\text{HOLD}}$, $\overline{\text{WP}}$ = V _{IH}			35 ⁽²⁾	μA

1. Industrial temperature limit is 5µA.

2. Industrial temperature limit is 25µA.

1.3 Program and Erase Characteristics

		2.5V to 3.6V			
Symbol	Parameter	Min	Тур	Мах	Units
t _{PP} ⁽¹⁾	Page Program Time (256 Bytes)		0.7	3.5	ms
t _{CHPE} ⁽¹⁾⁽²⁾	Chip Erase Time		4	12	sec

1. Maximum values indicate worst-case performance after 100,000 erase/program cycles.

2. Not 100% tested (value guaranteed by design and characterization).

2. Ordering Code

2.1 Ordering Code Detail

Ordering Code ⁽¹⁾	Package	Operating Voltage	Max. Freq. (MHz)	Operation Range	
AT25SF041-SHDHR-T	860				
AT25SF041-SHDHR-B	032		85MHz	Extended	
AT25SF041-SSHDHR-T	001	2.5V to 3.6V			
AT25SF041-SSHDHR-B	- 031			(10 0 10 120 0)	
AT25SF041-DWFHT ⁽²⁾	DWF				

1. The shipping carrier option code is not marked on the devices.

2. Contact Adesto for mechanical drawing or die sales information.

Package Type		
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline Package (JEDEC SOIC)	
8S2	8-lead, 0.208" Wide, Plastic Gull Wing Small Outline Package (EIAJ SOIC)	
DWF	Die in Wafer Form	

3. Revision History

Revision Level – Release Date	History
A – August 2014	Initial release.
B – October 2015	Corrected package type in Ordering Code Detail table.
C – August 2016	Added DWF part ordering code.



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